FIG.1

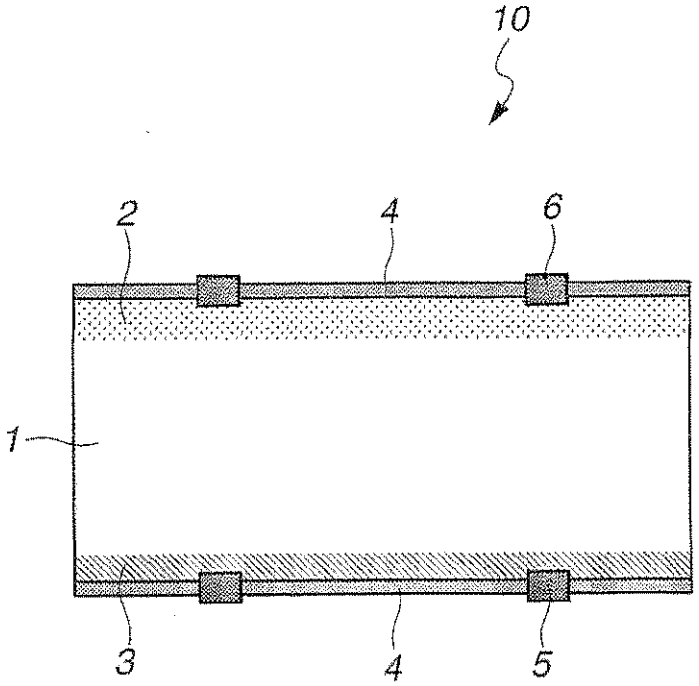
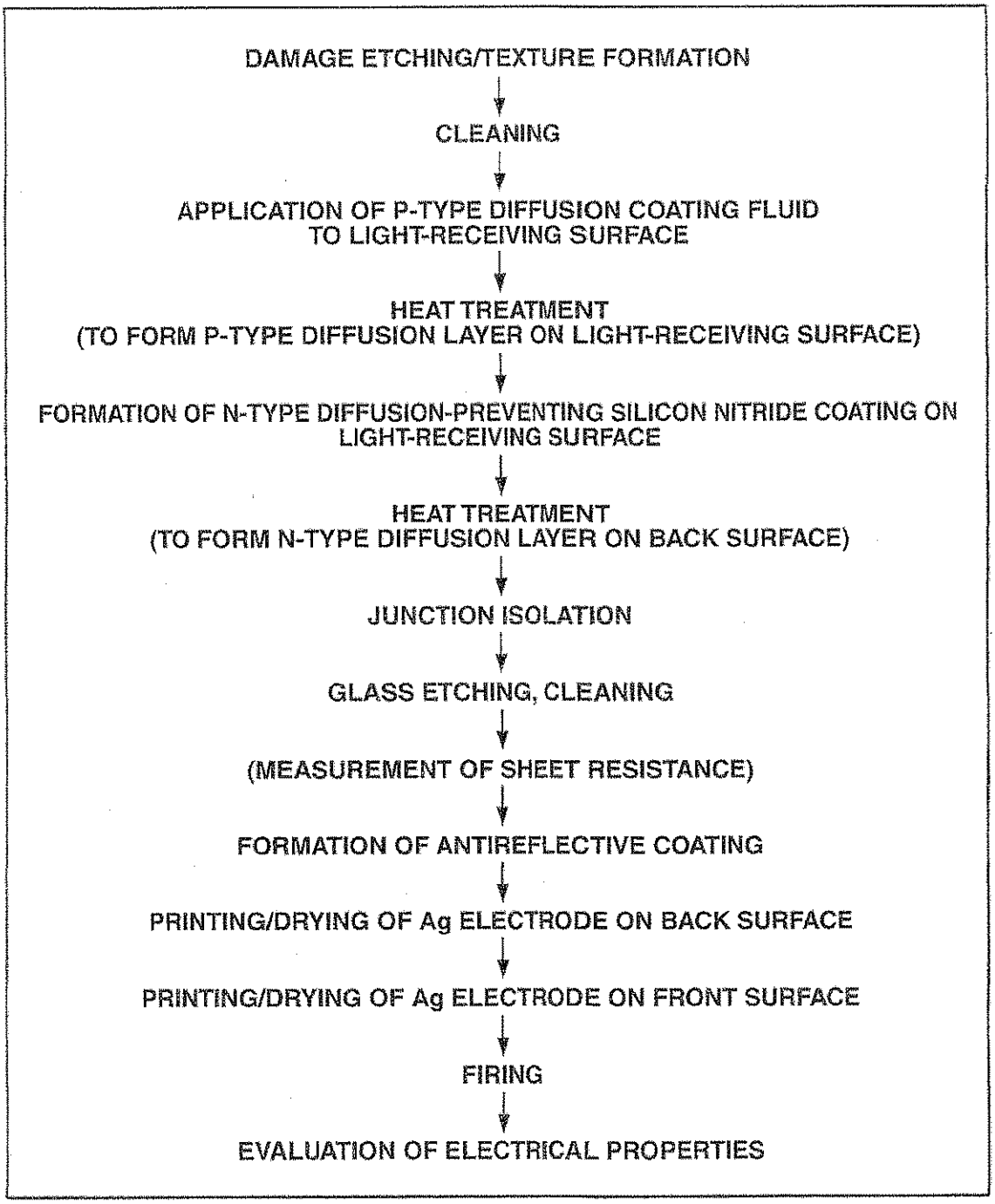


FIG.2


DAMAGE ETCHING/TEXTURE FORMATION
CLEANING
APPLICATION OF P-TYPE DIFFUSION COATING FLUID TO LIGHT-RECEIVING SURFACE
HEAT TREATMENT (TO FORM P-TYPE DIFFUSION LAYER ON LIGHT-RECEIVING SURFACE)
FORMATION OF N-TYPE DIFFUSION-PREVENTING SILICON NITRIDE COATING ON LIGHT-RECEIVING SURFACE
HEAT TREATMENT (TO FORM N-TYPE DIFFUSION LAYER ON BACK SURFACE)
JUNCTION ISOLATION
GLASS ETCHING, CLEANING
(MEASUREMENT OF SHEET RESISTANCE)
FORMATION OF ANTIREFLECTIVE COATING
PRINTING/DRYING OF Ag ELECTRODE ON BACK SURFACE
PRINTING/DRYING OF Ag ELECTRODE ON FRONT SURFACE
FIRING
EVALUATION OF ELECTRICAL PROPERTIES